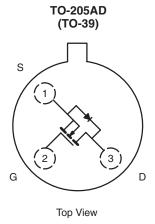


# JAN Qualified N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY							
V <sub>(BR)DSS</sub> Min (V)	$r_{DS(on)}$ Max ( $\Omega$ )	V <sub>GS(th)</sub> (V)	I <sub>D</sub> (A)				
60	3 at V <sub>GS</sub> = 10 V	0.8 to 2	0.99				



### **FEATURES**

· Military Qualified

• Low On-Resistence: 1.3 Ω

• Low Threshold: 1.7 V

Low Input Capacitance: 35 pFFast Switching Speed: 8 nsLow Input and Output Leakage

#### **BENEFITS**

- · Guaranteed Reliability
- · Low Offset Voltage
- Low-Voltage Operation
- · Easily Driven Without Buffer
- High-Speed Circuits
- Low Error Voltage

### **APPLICATIONS**

- Military Applications
- Direct Logic-Level Interface: TTL/CMOS
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- · Battery Operated Systems
- Solid-State Relays

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	60	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	I <sub>D</sub>	0.99		
Continuous Diam Current (1) = 130 O)	T <sub>C</sub> = 100 °C	'b	0.62	Α	
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	3		
Power Dissipation	T <sub>C</sub> = 25 °C	В	6.25	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.725		
Thermal Resistance, Junction-to-Ambient <sup>b</sup>		R <sub>thJA</sub>	170	°C/W	
Thermal Resistance, Junction-to-Case		R <sub>thJC</sub>	20		
Operating Junction and Storage Temperature Range		T <sub>J,</sub> T <sub>stg</sub>	- 55 to 150	°C	

#### Notes:

- a. Pulse width limited by maximum junction temperature.
- b. Not required by military spec.

## 2N6660JAN/JANTX/JANTXV

# Vishay Siliconix



<b>SPECIFICATIONS<sup>a</sup></b> T <sub>A</sub> = 25 °C, unless otherwise noted										
		Test Conditions		Limits						
Parameter	Symbol			Min	Typ <sup>b</sup>	Max	Unit			
Static			<u>.</u>							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = 10  \mu\text{A}$		60	75		\ \			
Gate Threshold Voltage		$V_{DS} = V_{GS}$ , $I_D = 1 \text{ mA}$		0.8	1.7	2				
	$V_{GS(th)}$		T <sub>C</sub> = - 55 °C			2.5	V			
			T <sub>C</sub> = 125 °C	0.3			1			
Gate-Body Leakage	1	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$				± 100	^			
	I <sub>GSS</sub>		T <sub>C</sub> = 125 °C			± 500	nA			
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V				1				
	I <sub>DSS</sub>		T <sub>C</sub> = 125 °C			100	μΑ			
On-State Drain Current	I <sub>D(on)</sub>	$V_{DS} = 10 \text{ V}, V_{G}$	<sub>S</sub> = 10 V		2		Α			
Drain-Source On-Resistance <sup>c</sup>		$V_{GS} = 5 \text{ V}, I_D = 0.3 \text{ A}$			2	5	Ω			
	r <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$ $T_C = 125 ^{\circ}\text{C}$			1.3	3				
					2.4	5.6				
Forward Transconductance <sup>c</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 7.5 V, I <sub>D</sub> = 0.525 A		170	350		mS			
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 0.99 A, V <sub>GS</sub> = 0 V		0.7	0.8	1.6	V			
Dynamic			•		•	<u>'</u>				
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz			35	50	- pF			
Output Capacitance	C <sub>oss</sub>				25	40				
Reverse Transfer Capacitance	C <sub>rss</sub>				7	10				
Drain-Source Capacitance	C <sub>ds</sub>				30					
Switching <sup>d</sup>	,		<u>'</u>							
Turn-On Time	t <sub>ON</sub>	$V_{DD}$ = 25 V, $R_L$ = 23 $\Omega$ $I_D \cong 1$ A, $V_{GEN}$ = 10 V, $R_g$ = 25 $\Omega$			8	10	ns			
Turn-Off Time	t <sub>OFF</sub>				8.5	10				

#### Notes:

- a.  $T_A = 25$  °C unless otherwise noted.
- b. FOR DESIGN AID ONLY, not subject to production testing.
- c. Pulse test: PW  $\leq$  300  $\mu s$  duty cycle  $\leq$  2 %.
- d. Switching time is essentially independent of operating temperature.
- e. For typical characteristics curves see the 2N6659/2N6660, VQ1004J/P data sheet.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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